

AN2983 Application note

Constant current inverse buck LED driver using L6562A

Introduction

Whenever a lighting application, such as street lighting for example, requires an elevated number of LEDs, there are basically two solutions: the first is to connect all the diodes in series in a single "string"; the second is to place several strings in parallel with fewer elements in each one.

The first solution, even if simpler, poses stringent safety requirements due to the high supply voltage. The latter needs a lower input voltage but the current through each string has to be independently controlled.

Since, from a system point of view, the second solution seems more viable, we have developed an application to investigate the possibility of employing an L6562A to implement such a constant current controller. This document describes the EVL6562A-LED demonstration board and summarizes the relevant results obtained.

CM 1 2 3 4 5

Figure 1. EVL6562A-LED: L6562A constant current inverse buck driver module

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Main characteristics AN2983

1 Main characteristics

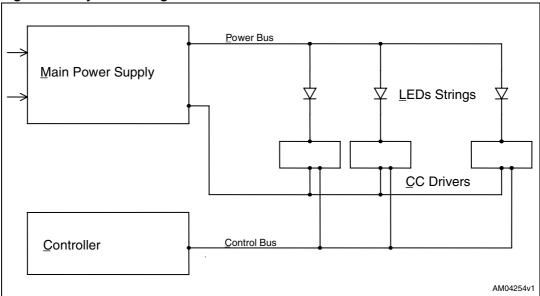
1.1 System configuration

Figure 2 shows a possible system configuration, in which the key modules are:

- the main power supply, which converts the AC input voltage to an internal power bus.
- the CC drivers, which are the modules that implement the constant current sources.
- the controller that configures the CC current drivers through a dedicated bus.
- the LEDs strings.

The CC drivers are the modules considered in this application note and implemented in the EVL6562A-LED demonstration board.

Figure 2. System configuration



1.2 Requirements

The board's design takes into account the following key points.

- Input voltage: 48 V (+/- 20%)
- Output current (average): 0.35 A
- Output ripple current < 140 mA (+/- 20%)
- Output current setting/calibration
- Digital dimming
- Open-/short-circuit protection
- Absence of electrolytic capacitors

The design can be easily changed to adapt to different needs.

AN2983 Main characteristics

1.3 Interface

Ideally the module should have only two pins and behave as a constant current sink, but for practical reasons, and in order to gain a higher degree of flexibility, its connector has the following pinout.

Table 1. EVL6562A-LED interface

Pin number	Signal name	Connection	Notes
1	D_Dimm	Shutdown / digital dimming	Digital input
2	C_Set	Load current setting	0 12 V input
3	Gnd	Auxiliary power (Gnd)	
4	Gnd	Auxiliary power (Gnd)	
5	Vcc	Auxiliary power (Vcc)	(18 V) input/output
6	n.c.		
7	Vin_Gnd	Main power (Gnd)	
8	Vin	Main power (Vin)	(48 V nom.) input
9	LEDs_A	LEDs anode Interconnection	Output
10	LEDs_K	LEDs cathode interconnection	Output

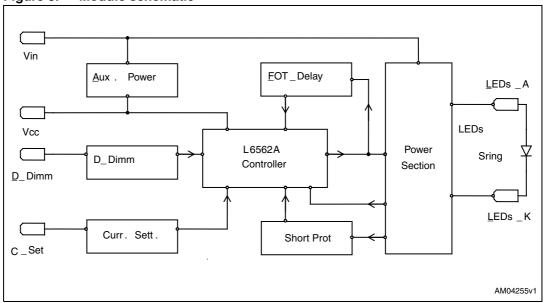
- D_Dimm is a digital (TTL) input for the module. A high level shuts off the circuit. A low level enables the nominal load current and a square wave with variable duty cycle can be used as a dimming control
- C_Set is an analog input (0...12 V). A voltage applied to this pin is used to set the load current to the required value
- Gnd pins 3 and 4 are the ground return for the controller's power supply (Vcc). D_Dimm and C_set are referred to this ground
- Vcc is the connection to the controller's power supply input
- Vin_Gnd is the main power supply return, internally connected to the Gnd pins
- Vin is the main power supply input (48 V)
- LEDs_A is the connection to the anode of the diode string
- LEDs_K is the connection to the cathode of the diode string

2 Circuit description

The following is a list of the main components that form the module EVL6562A-LED.

- Power section
- L6562A controller
- Fixed off time (FOT) delay
- Current setting
- LED number compensation
- Shutdown/dimming
- Auxiliary power
- Open-/short-circuit protection

Figure 3. Module schematic

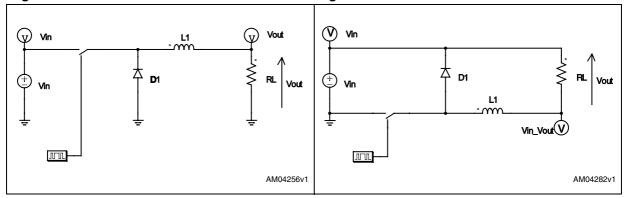


2.1 Power section

The topology of this stage is the so-called inverse buck (also referred to as modified or low-side buck). Simply stated, it is a standard buck converter with the power and ground connections interchanged, as shown in *Figure 4* and *Figure 5*.

Figure 4. Standard buck converter

Figure 5. Inverse buck converter



Other than the power and ground connections being exchanged, there are no differences between the two configurations; the behavior and dimensioning of the inverse buck are the same as that of the standard buck. Refer to application note AN2928^(a) for a detailed description and design rules. The following are a reminder of the fundamental applicable equations.

Inductor current variation (charging period)

Equation 1

$$\Delta I_ton = \left\lceil \frac{Vin - VLed}{L} \right\rceil * ton$$

Inductor current variation (discharging period)

Equation 2

$$\Delta I_{toff} = \left\lceil \frac{VLed}{L} \right\rceil * toff$$

The circuit works in continuous conduction mode, then in steady-state the current variations during *ton* and *toff* are the same (in module) and equivalent to the ripple current I_rip.

Ripple current

Equation 3

$$I_rip = |\Delta I_ton| = |\Delta I_toff|$$

Duty cycle

Equation 4

$$D = \left\lceil \frac{ton}{T} \right\rceil = \left\lceil \frac{VLed}{Vin} \right\rceil$$

Additionally, the average current of the LED can be expressed as:

a. See Chapter 5: References on page 30.

Equation 5

$$I_Led_avg = I_Led_pk - \frac{1}{2}I_rip$$

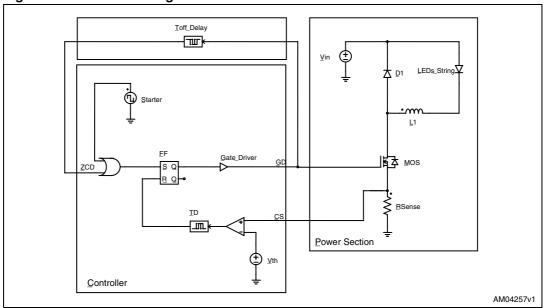
Equation 6

$$I_Led_avg = I_Led_pk - \frac{1}{2} \left[\frac{VLed}{L} \right] * toff$$

2.2 L6562A controller

The L6562A is used in a "fixed off time" and "peak current mode" topology. *Figure 6* represents the controller with its main functional blocks, the FOT_Delay circuitry and the power section.

Figure 6. Controller diagram



At power-on, the "starter" sets the flip-flop, whose output (Q) goes high activating the gate driver (GD).

The power MOSFET transistor is turned on and the load current (I_Led) flows through the LED diodes, inductor, power MOSFET transistor and sense resistor.

The load current develops a voltage on the sense resistor: $V_S = I_Led * RSense$.

This voltage is applied to the CS input of the controller where it is compared to the reference voltage $Vth = 1.08\ V$ (nom.)

When Vs becomes higher than Vth, the comparator's output goes high, activating the reset input of the FF.

The FF Q output is set to low and the gate driver output voltage goes to gnd.

The power MOSFET is turned off, Vs goes to zero and the I_Led current decreases, flowing through the LEDs, inductor and Flywheel diode.

> The falling edge of the gate driver starts the toff delay (see Section 2.3 on page 9). At the end of the toff delay the set input of the FF is activated and a new cycle begins.

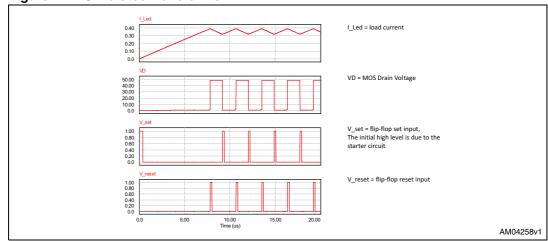


Figure 7. Simulated waveforms

2.3 FOT (fixed off time) delay circuit

Figure 8. **FOT** net Œ ZCD Comparato FF S R18 5**V**7 Toff_Delay Controller AM04259v1

The fixed off time delay circuit is implemented by connecting the gate drive (GD) output to the ZCD input by means of a diode D5 in series with R11 and C7 (in parallel), and ZCD to ground with R18 and C8 in parallel.

There is a clamp circuit behind the ZCD pin of the controller that limits the maximum voltage to 5.7 V, and a comparator whose output goes high if the input voltage falls below the threshold level of 0.7 V.

Hence when GD is high (10 V nominal), ZCD is forced to the clamp level of 5.7 V, but as soon as the gate driver goes low, the diode D5 turns off and the capacitor C8 discharges through R18 until the voltage reaches 0.7 V.

At this point the comparator switches on and triggers the set input of the flip-flop, whose output goes high.

This causes the gate driver to go high again and then the power MOSFET to conduct.

The time delay *toff* is simply governed by the equation of the discharge of the capacitor C8 through the resistor R18 with the boundary conditions V(t0) = 5.7 V, V(t1) = 0.7 V.

Equation 7

$$V(t_1) = V(t_0) * e^{-\left[\frac{(toff)}{R18*C8}\right]}$$

Equation 8

$$\ln\left[\frac{V(t_1)}{V(t_0)}\right] = -\left[\frac{toff}{R_{18} * C_8}\right]$$

Equation 9

toff =
$$(R_{18} * C_8) * In \left[\frac{V(t_0)}{V(t_1)} \right]$$

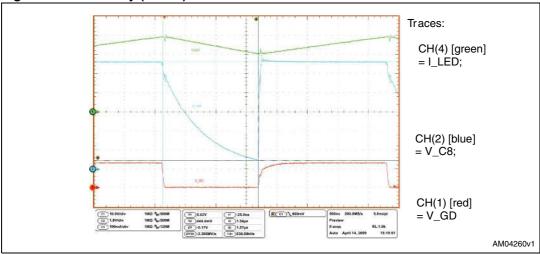
With our values this gives:

Equation 10

toff =
$$(R_{18} * C_8) * In \left[\frac{5.7}{0.7} \right] = 2.1 * (R_{18} * C_8) = 1.17 \mu S$$

Refer to AN2782^(b) for a detailed description of the FOT controller. *Figure 9* shows the key waveforms with the LEDs' current (I_LED), capacitor (C8) voltage (V_C8) and gate drive output voltage (V_GD).

Figure 9. toff delay (actual)



It is worth noting that the real *toff* time is 1.57 μ S and that the low threshold is 0.44 V. This is due to the components' tolerance and to the propagation delay from the comparator input to the gate driver output.

b. See Chapter 5: References on page 30.

> If we consider the time at which the capacitor voltage crosses the 0.7 V threshold, the equivalent toff time is 1.32 μS (+150 nS compared to the nominal value, due to the tolerance of C8 and stray capacitance) while the remaining 250 nS are related to the propagation delay (during which the voltage falls from 0.7 V to 0.44 V).

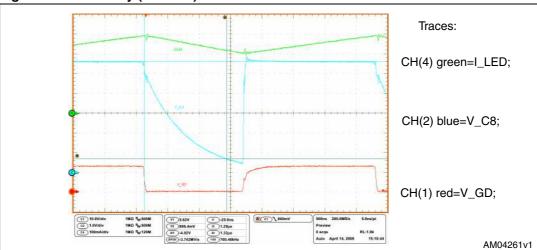


Figure 10. toff delay (nominal)

2.4 **Current setting**

As already indicated, the CS pin of the L6562A controller is internally connected to the noninverting input of the CS comparator, whose threshold (Vth) is fixed to 1.08 V (nom.)

Tying it to the sense resistor forces the comparator's output high when I_Led = Vth / RS.

This is a very simple way to detect – and limit – the peak load current to a fixed value.

In order to make this value adjustable, we can introduce an auxiliary voltage source (Va), connected to the CS pin through a resistor (Ra) and another resistor (Rb) between CS and the sense resistor, as indicated in Figure 11. In this way the auxiliary source can be used to modify the threshold at which the (peak) load current triggers the comparator.

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Figure 11. Current setting

Equation 11

$$Vth = Vs - Ib * Rb$$

Equation 12

$$Vth = Va - Ia * Ra$$

Neglecting the current that flows though the CS pin (1 µA max):

Equation 13

$$lb = -la$$

And then:

Equation 14

$$Vth = Vs - Ib * Rb$$

Equation 15

$$Vth = Va + Ib*Ra$$

Then:

Equation 16

$$Vs = Vth + Ib*Rb$$

and:

Equation 17

$$Ib = \left(\frac{1}{Ra}\right)^* (Vth - Va)$$

Equation 18

$$Vs = Vth + \left(\frac{1}{Ra}\right)^* (Vth - Va)^* Rb$$

Equation 19

$$Vs = Vth + \left(\frac{Rb}{Ra}\right)^* Vth - \left(\frac{Rb}{Ra}\right)^* Va$$

Equation 20

$$Vs = Vth * \left(\frac{Ra + Rb}{Ra}\right) - Va * \left(\frac{Rb}{Ra}\right)$$

Equation 21

$$I_Led_pk = \left(\frac{1}{Rs}\right)^* \left[Vth^* \left(\frac{Ra + Rb}{Ra}\right) - Va^* \left(\frac{Rb}{Ra}\right) \right]$$

If we consider the limit condition Va = 0, which is equivalent to connecting Ra directly to ground, the maximum peak LED current I_Led_pk (max) can be obtained by:

Equation 22

$$I_Led_pk(max) = I_Led_pk(nom) * \left(\frac{Ra + Rb}{Ra}\right)$$

Where, as already seen, the (nominal) LED peak current is:

Equation 23

$$I_Led_pk(nom) = \left(\frac{1}{Rs}\right)^* Vth$$

On the other hand, if we fix I_Led_pk = 0 we can estimate the value of Va for which the LED current is reduced to zero.

Equation 24

$$0 = \left(\frac{1}{Rs}\right) * \left[Vth * \left(\frac{Ra + Rb}{Ra}\right) - Va * \left(\frac{Rb}{Ra}\right) \right]$$

Equation 25

$$Va * \left(\frac{Rb}{Ra}\right) = Vth * \left(\frac{Ra + Rb}{Ra}\right)$$

Equation 26

$$Va = Vth * \left(\frac{Ra + Rb}{Rb}\right)$$

With our values of Ra = R19 = 10 k Ω , and Rb = R14 = 1 k Ω , *Equation 21* can be rewritten as:

Equation 27

I_Led_pk =
$$\left(\frac{1}{Rs}\right)^* \left[(1.1)^* Vth - (0.1)^* Va \right]$$

Equation 22 becomes:

Equation 28

$$I_Led_pk(max) = I_Led_pk(nom)*(1.1)$$

And Equation 25:

Equation 29

$$Va = Vth * (11)$$

In the plot shown in *Figure 12* the LED current (I_Led) is expressed as a function of the trim voltage V_trim (= Va) applied at the C_set module input, with the supply voltage (Vin) as parameter (fixed at 36, 48 and 60 V).

As you can see, the linearity is quite good for currents in the range of 400 to 75 mA and voltages in the range 0... 10 V, while with V_trim from 10 to 12 V the current still decreases down to zero, but with some non-linearity.

This is due to the fact that the LED diodes are a non-linear load and their behavior at low current levels may change from one device to another.

Another point that has to be taken into account is that when the average current is reduced, the minimum LED current is reduced to zero, causing the converter to change from continuous conduction mode (CCM) to discontinuous conduction mode (DCM) operation.

450 400 350 300 LED [mA] 250 -I_LED (36_V) 200 -I_LED (48_V) 150 -I_LED (60_V) 100 50 10 V_trim [V] AM04263v1

Figure 12. I_Led/V_trim

2.5 LED number compensation

The average output current depends on the number of LEDs connected to the module, or to be more precise, on the voltage (VLed) developed across them. This is due to the fact that:

Equation 30

$$I_Led_avg = I_Led_pk - \frac{1}{2}I_rip$$

and:

Equation 31

$$I_rip = \left(\frac{toff}{L}\right)^* VLed$$

and then:

Equation 32

$$I_Led_avg = I_Led_pk - \frac{1}{2} \left(\frac{toff}{L}\right)^* VLed$$

With a constant I_Led_pk, toff and L, it appears that if VLed increases, the average current decreases, and vice versa.

Usually the number of LEDs is determined in the early stages of the design phase, but if required, it is possible to make the load current almost independent of the number of LEDs employed by connecting two resistors (R17 and R20) from the LEDs' cathode to the CS pin of the controller.

With a technique similar to that of the current setting, the circuit senses the voltage [Vin - VLed] that depends on the number of LEDs and corrects the voltage applied to the current sense pin.

In this way the circuit behaves as if the internal comparator triggers when the average current – instead of the peak current – exceeds the threshold value.

The drawback of this configuration is that since the circuit is now more sensitive to input voltage variations, Vin has to be more tightly regulated.

The following equations demonstrate what has been previously asserted.

Equation 33

$$I_Led_avg = I_Led_pk - \frac{1}{2} \left(\frac{toff}{L}\right)^* VLed$$

Equation 34

$$I_Led_pk = \left(\frac{1}{Rs}\right) * \left[Vth * \left(\frac{Ra + Rb}{Ra}\right) - Va * \left(\frac{Rb}{Ra}\right)\right]$$

Where: I_Led_avg is the LEDs' average current, I_Led_pk is the LEDs' peak current and Va = (Vin - VLed) is the LEDs' cathode voltage.

Equation 35

$$I_Led_avg = \left(\frac{1}{Rs}\right)^* \left[Vth * \left(\frac{Ra + Rb}{Ra}\right) - \left(Vin - VLed\right)^* \left(\frac{Rb}{Ra}\right)\right] - \frac{1}{2} \left(\frac{toff}{L}\right)^* VLed + \frac$$

Equation 36

$$\begin{split} I_Led_avg = & \left(\frac{1}{Rs}\right)^* \left[Vth^*\left(\frac{Ra + Rb}{Ra}\right) - Vin^*\left(\frac{Rb}{Ra}\right)\right] + \\ & + VLed^*\left[\left(\frac{1}{Rs}\right)^*\left(\frac{Rb}{Ra}\right) - \frac{1}{2}\left(\frac{toff}{L}\right)\right] \end{split}$$

To make I_Led_avg independent of VLed, the VLed coefficient has to be reduced to zero.

Equation 37

$$\frac{1}{Rs} * \left(\frac{Rb}{Ra}\right) - \frac{1}{2} \left(\frac{toff}{L}\right) = 0$$

That is to say, setting:

Equation 38

$$\left(\frac{Rb}{Ra}\right) = \frac{1}{2}\left(\frac{toff}{L/Rs}\right) = 0$$

reduces Equation 36 to:

Equation 39

$$I_Led_avg = \left(\frac{1}{Rs}\right)^* \left[Vth * \left(\frac{Ra + Rb}{Ra}\right) - \left(Vin\right)^* \left(\frac{Rb}{Ra}\right)\right]$$

In other words, connecting Ra to the cathode of the LEDs' string, the average LED current depends only on Vth and Vin.

Going into further detail, we also have to consider the delay of the current sense comparator (tdel) and modify *Equation 33* as follows.

Equation 40

$$I_Led_avg = I_Led_pk - \frac{1}{2}I_rip + I_del$$

With:

Equation 41

$$I_{del} = \left(\frac{tdel}{L}\right)^* \left(Vin - VLed\right)$$

Equation 42

$$\begin{split} I_Led_avg = & \left(\frac{1}{Rs}\right)^* \left[Vth^*\left(\frac{Ra + Rb}{Ra}\right) - Vin^*\left(\frac{Rb}{Ra}\right)\right] + Vin^*\left(\frac{tdel}{L}\right) + \\ & + VLed^*\left[\left(\frac{1}{Rs}\right)^*\left(\frac{Rb}{Ra}\right) - \frac{1}{2}\left(\frac{toff}{L}\right)\right] - VLed^*\left(\frac{tdel}{L}\right) \end{split}$$

Equation 43

$$\begin{split} I_Led_avg &= \left(\frac{1}{Rs}\right)^* \left[Vth^* \left(\frac{Ra + Rb}{Ra}\right) - Vin^* \left[\left(\frac{Rb}{Ra}\right) - \left(\frac{tdel}{L/Rs}\right) \right] \right] + \\ &+ VLed^* \left[\left(\frac{1}{Rs}\right)^* \left(\frac{Rb}{Ra}\right) - \frac{1}{2} \left(\frac{toff}{L}\right) - \left(\frac{tdel}{L}\right) \right] \end{split}$$

And with Equation 38 that now becomes:

Equation 44

$$\left(\frac{\mathsf{Rb}}{\mathsf{Ra}}\right) = \frac{1}{2} \left(\frac{\mathsf{toff}}{\mathsf{L/Rs}}\right) + \left(\frac{\mathsf{tdel}}{\mathsf{L/Rs}}\right)$$

And Equation 40:

Equation 45

$$I_Led_avg = \left(\frac{1}{Rs}\right)^* \left[Vth^*\left(\frac{Ra + Rb}{Ra}\right) - Vin^*\left[\left(\frac{Rb}{Ra}\right) - \left(\frac{tdel}{L/Rs}\right)\right]\right]$$

With the values of our application:

Equation 46

toff = 1.57
$$\mu$$
S, tdel = 0.2 μ S, L = 470 μ H, Rs = 2.8 Ω

Equation 47

$$\left(\frac{L}{Rs}\right) = \left(\frac{470 * 10^{-6}}{2.8}\right) = \left(1.68 * 10^{-4}\right) S$$

Equation 48

$$\frac{1}{2}$$
 (toff) + (tdel) = (0.985 * 10⁻⁶)S

And then:

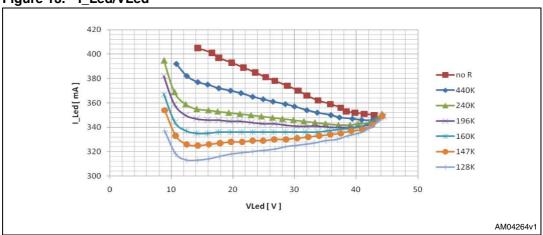
Equation 49

$$\left(\frac{\text{Ra}}{\text{Rb}}\right) = \frac{\left(1.68 * 10^{-4}\right)}{\left(0.985 * 10^{-6}\right)} = 170$$

On the demonstration board several measures have been taken with Vin = 48 V, and Rb = 1 $k\Omega$.

Figure 13 is the plot of the LED current as a function of the voltage on the LED string (VLed) with Ra (actually R17 + R20) as a parameter.

Figure 13. I Led/VLed



2.6 Shutdown/dimming

The D_Dim input (pin 1 of the J1 connector) has a dual function.

- Module enable
- Digital (PWM) dimming

Forcing it low, or leaving it floating, enables the controller's normal activity (current sink), while pulling it high (> 2.7 V) causes the module to shut down. Therefore, this input can be used to switch the load on and off.

Figure 14 and Figure 15 highlight the turn-on and turn-off with an input voltage (Vin) of 48 V and an equivalent output voltage (VLed) of 20 V. In these conditions, the rise and fall times of the load current are lower than 10 μ S.

Applying a square wave to this pin forces the module to 'work and stop' at the input signal frequency; in this way the average load current can be modified by simply changing the duty cycle of the PWM control.

Supposing a dimming frequency of 200 Hz is used, and taking into account the 10 μ S of rise/fall time of the LED current, we can estimate the minimum dimming as (20 uS)*(200 Hz) = 0.4%.

Figure 16, 17, 18, 19, and *20* show the LED current for different dimming factors between 1% and 99%.

Note:

 $R1 = 10 \text{ k}\Omega$, C9 = 100 pF, and D1 = 5.6 V Zener diode. All these devices have been introduced to protect the controller from excessive input voltages or noise; in a complete system, with a driver directly connected, they can be avoided.

Figure 14. Enable/dimming detailed view (turn-on)

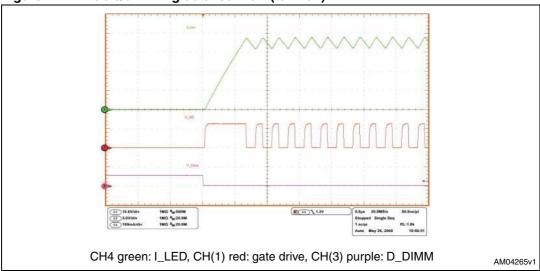


Figure 15. Enable/dimming detailed view (turn-off)

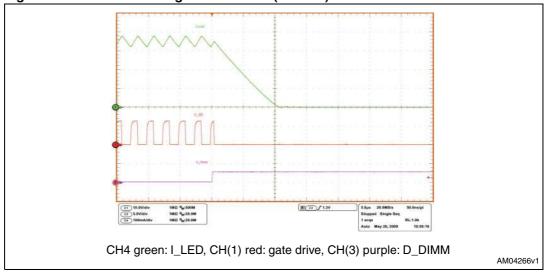


Figure 16. Dimming 1%

Figure 17. Dimming 10%

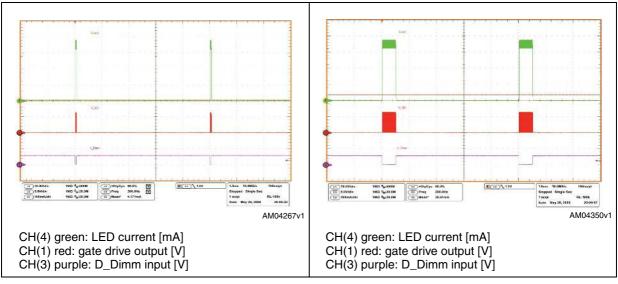


Figure 18. Dimming 50%

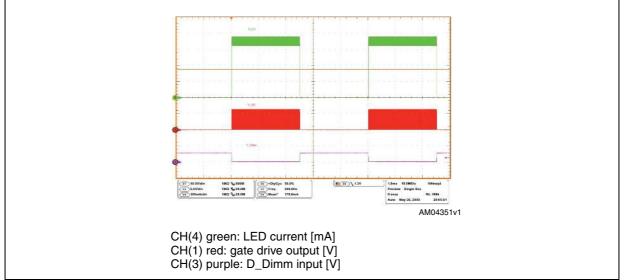


Figure 19. Dimming 90%

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Figure 20. Dimming 99%

CH(4) green: LED current [mA]

CH(1) red: gate drive output [V]

CH(3) purple: D_Dimm input [V]

CH(4) green: LED current [mA] CH(1) red: gate drive output [V] CH(3) purple: D_Dimm input [V]

2.7 Auxiliary power

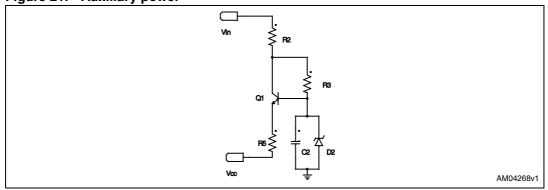
The components for the auxiliary power supply are Q1, D2, C2, R2, R3, and R5.

This section is included as a commodity to reduce the main voltage (48 V nominal) to the 18 V required from the Vcc input of the L6562A controller, thus avoiding the use of another power supply. It has been designed to work with input voltages in the range of 33 to 65 V, but can be easily resized for different ranges.

Note that it is a linear regulator and that its efficiency is not very good. For this reason, in real applications where multiple modules are employed, it is better to consider a solution with an external supply common to all the modules.

Simply removing R2 and R5 disconnects the entire block and allows the power supply (Vcc) to be provided from pin 5 of the header connector.

Figure 21. Auxiliary power



2.8 Open-/short-circuit protection

As indicated, one of the requirements is that the module can sustain open and short circuits indefinitely and restart the correct functionality as soon as the fault is removed.

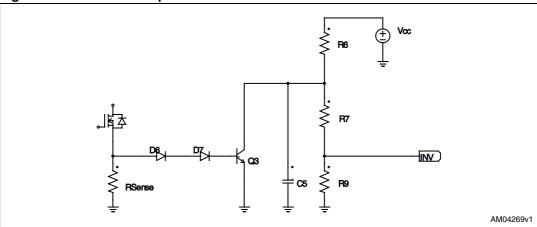
From the "open circuit" point of view the module is intrinsically safe: if the load is disconnected, no current runs through the sense resistor and the controller drives the power MOSFET transistor in conduction and pin 10 of the J1 connector to ground. Whenever the load is reconnected, the current restarts to flow and normal operation is resumed.

The short-circuit condition is more critical. At the end of the *toff* delay, the power MOSFET is turned on, the current starts to flow and charges the inductor, and the voltage on the sense resistor quickly reaches the threshold level. However, because of the controller's internal delay (175 nS nom.) the power MOSFET does not shut down immediately; as such, a minimal amount of energy is still transferred to the inductor, but during the *toff* time – since the load is a short-circuit – this energy is NOT dissipated.

The result is that the load current rises abnormally, leading to catastrophic failure unless the cycle is blocked.

For this reason the circuit outlined in *Figure 22* has been introduced.

Figure 22. Short-circuit protection



In normal conditions the voltage developed across the sense resistor is not sufficient to turn on Q3. The INV pin of the controller is then at:

Equation 50

$$(Vcc)*\left(\frac{R9}{R6+R7+R9}\right)=(18V)*\left(\frac{22K}{(220K+33K+22K)}\right)=1.44V$$

On the other hand, in the case of a short-circuit, the load current increases until Q3 goes in conduction, C5 is discharged and the INV pin goes to:

Equation 51

$$\left(Q3_Vce_sat \right) * \left(\frac{R9}{R7 + R9} \right) = \left(0.25V \right) * \left(\frac{22K}{\left(33K + 22K \right)} \right) = \left(0.25 \right) * \left(0.4 \right)V = 0.1V$$

The controller then shuts down, the power MOSFET stops conducting, the inductor discharges and the load current decays to zero. Since no current flows through the sense

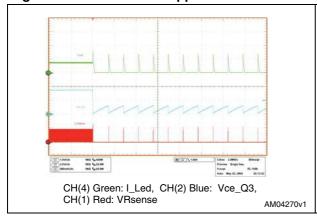
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resistor, Q3 turns off allowing C5 to charge through R6, and the voltage of the INV pin rises again. When it reaches 0.45 V the disable condition is removed and the controller restarts.

If the short-circuit condition is removed, the circuit restores its normal functionality. If the short-circuit condition persists, the hiccup cycle is repeated.

Figure 23. Short-circuit application

Figure 24. Short-circuit removal



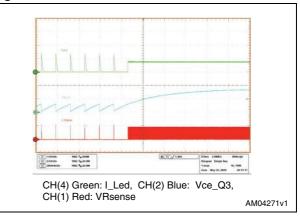
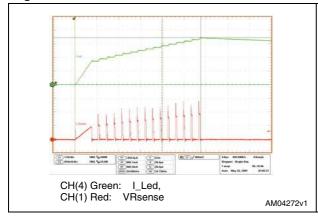
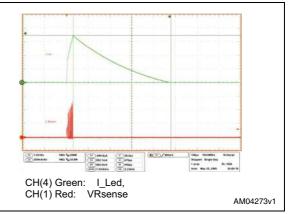


Figure 25. Short-circuit detection

Figure 26. Load current decay





Measurements AN2983

3 Measurements

3.1 LED voltage dependency

The first set of measures was taken at a nominal input voltage with Vin = 48 V and with the output voltage (Vled) as a parameter.

Figure 27. LED current (average, maximum, minimum)

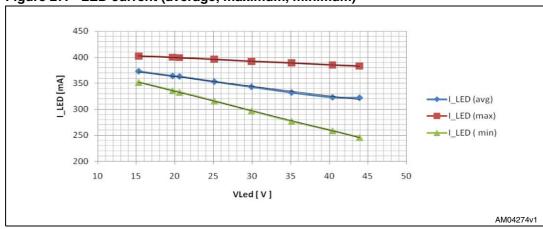
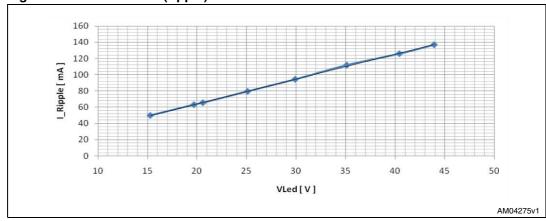


Figure 28. LED current (ripple)



AN2983 Measurements

Figure 29. Switching frequency

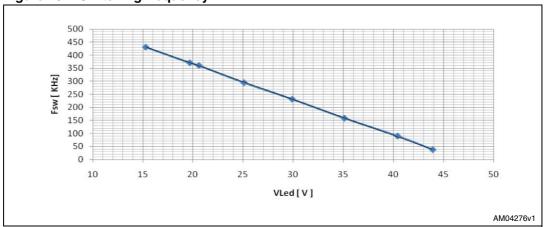
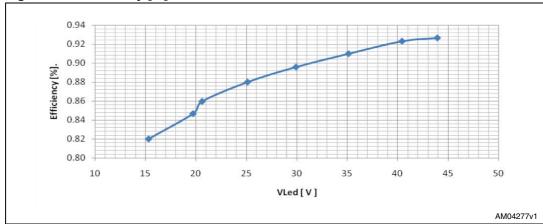


Figure 30. Efficiency [%]



AN2983 Measurements

Input voltage dependency 3.2

A second set of measures was taken varying the input voltage from 36 to 60 V with several load conditions as parameters (VLed from 15 to 45 V).

Figure 31. LED current (average)

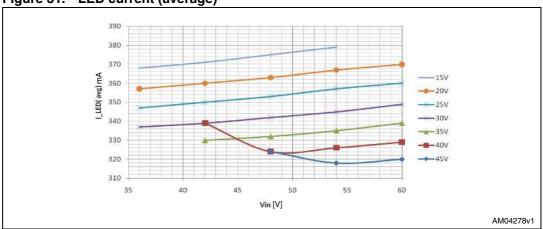


Figure 32. **Switching frequency**

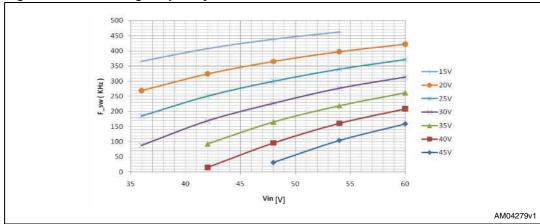
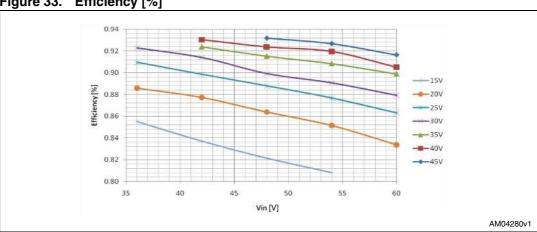


Figure 33. Efficiency [%]



4 Electrical schematic and bill of materials

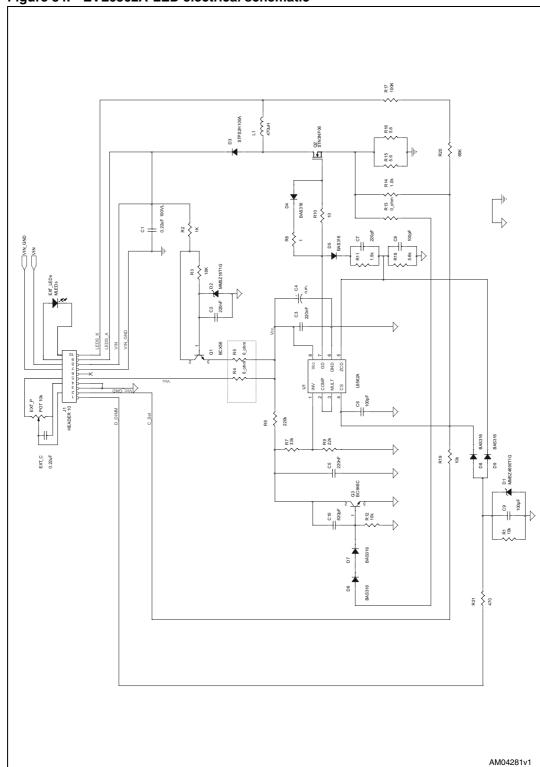


Figure 34. EVL6562A-LED electrical schematic

Table 2. EVL6562A-LED BOM

Table		LVL0302A-LLD BOW		T I	
Item	Qty	Reference	Part	PCB footprint	Notes
1	1	C1	0.22 μF 100VL	1812	
2	3	C2,C3,C5	220 nF	805	
3	1	C4	Not mounted		
4	3	C6,C8,C9	100 pF	805	
5	1	C7	220 pF	805	
6	1	C10	820 pF		
7	1	D1	MMSZ4690T1G	SOD-123	
8	1	D2	MMSZ18T1G	SOD-123	
9	1	D3	STPS2H100A	SMA	STMicroelectronics
10	6	D4,D5,D6,D7, D8,D9	BAS316	SOD-323	
11	1	EXT C	0.22 μF		External jig
12	1	EXT LEDs	MLEDs		LEDs string
13	1	EXT P	POT 10 kΩ multiturns		External jig
14	1	J1	Strip header, 10-pin, 90°, 2.54 mm pitch		
15	1	L1	470 μH		Coilcraft MMS1260-474KLB
16	1	Q1	BCX56	SOT-89	
17	1	Q2	STN3NF06	SOT-223	STMicroelectronics
18	1	Q3	BC846C	SOT-23	
19	3	R1,R12,R19	10 kΩ	805	
20	1	R2	1 kΩ	1206	
21	1	R3	18 kΩ	1206	
22	3	R4,R5,R13	0 Ω	805	
23	1	R6	220 kΩ	805	
24	1	R7	33 kΩ	805	
25	1	R8	1 Ω	805	
26	1	R9	22 kΩ	805	
27	1	R10	10 Ω	805	
28	1	R11	1.5 kΩ	805	
29	1	R14	1.0 kΩ	805	
30	2	R15,R16	5.6 Ω	1210	
31	1	R17	100 kΩ	805	
32	1	R18	5.6 kΩ	805	
33	1	R20	68 kΩ	805	

Table 2. EVL6562A-LED BOM (continued)

Item	Qty	Reference	Part	PCB footprint	Notes
34	1	R21	470	805	
35	1	U1	L6562A	SO-8	STMicroelectronics

References AN2983

5 References

- 1. AN2928
- 2. AN2782
- 3. L6562A datasheet

Note: These references are available on the STMicroelectronics web site at www.st.com.

AN2983 Revision history

6 Revision history

Table 3. Document revision history

Date	Revision	Changes
16-Dec-2009	1	Initial release.

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